



CKT	DIM A	DIM B	DIM C
2	2.00	8.00	4.75
3	4.00	10.00	6.75
4	6.00	12.00	8.75
5	8.00	14.00	10.75
6	10.00	16.00	12.75
7	12.00	18.00	14.75

- NOTES:
- MATERIAL:
 - 1.1 HOUSING: HALOGEN FREE PLASTIC, HIGH TEMP., PA9T,WHITE,UL94V-0;
 - 1.2 CONTACT: BRASS C2680
 - 1.3 FITTING NAIL: BRASS C2680
 - FINISH:
 - 2.1 TERMINA FINISH :
 - 50u"MIN NICKEL UNDERPLATING OVERALL.
 - N: 80u"MIN MATT TIN ON CONTACT AND SOLDER AREA.
 - 2.3 FITTING NAIL FINISH:
 - 50u"MIN NICKEL UNDERPLATING OVERALL.
 - N: 80u"MIN MATT TIN OVERALL

- REFLOW SOLDER CAPABLE TO 260°C PER ACES SPEC.
- SPEC. PLS. REFER TO PS-51206-xxxx-xxx
- PACKAGE PLS. REFER TO 51313-xxxx-xx-TRP

51313-XXX X X -XXX

No Of Contact | | 001: Natural
 Packing | | Plating
 O:Tape & Reel | | N: Matt Tin

QUALITY SYMBOLS MAJOR CRITICAL GENERAL TOLERANCES (UNLESS SPECIFIED) X. ±0.5 .X ±0.25 .XX ±0.15 .XXX ±0.1 ANGLES ±2°	DRAWN BY Liang,lin ji DATE 18/09/11	 ACES ELECTRONICS TITLE 2.0mm WTB CONN. SMT R/A S/R TYPE SIZE A4 RFG NO. NA	
	CHECKED BY Lu, jing quan DATE 18/09/11		REV B DWG NO. 51313-xxxx-xxx
	APPROVED BY hsieh,fu yu DATE 18/09/11		SCALE 2:1 SHEET NO. 1 OF 1
	UNITS mm		 SIZE A4